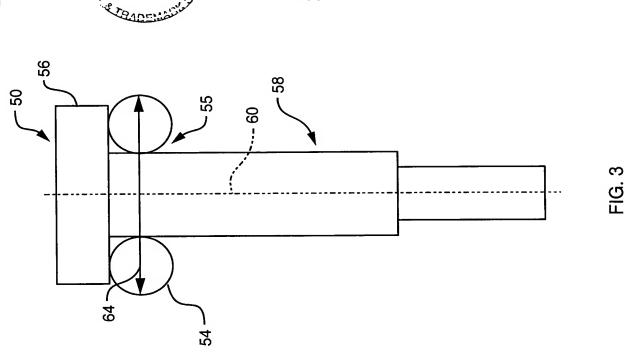
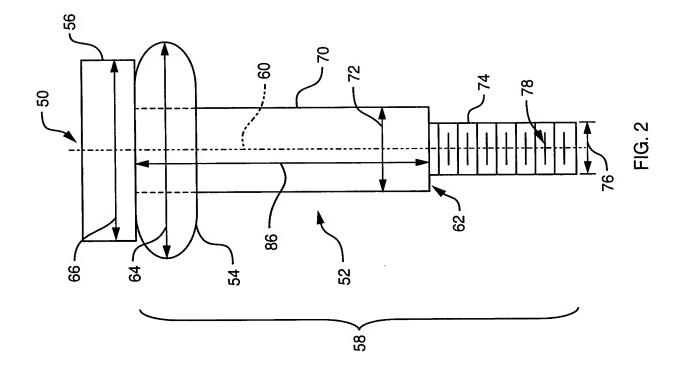




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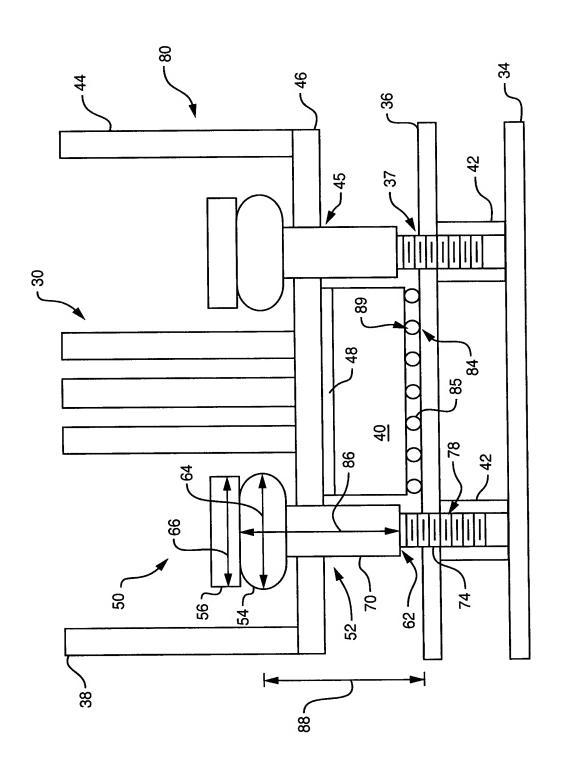


FIG. 4



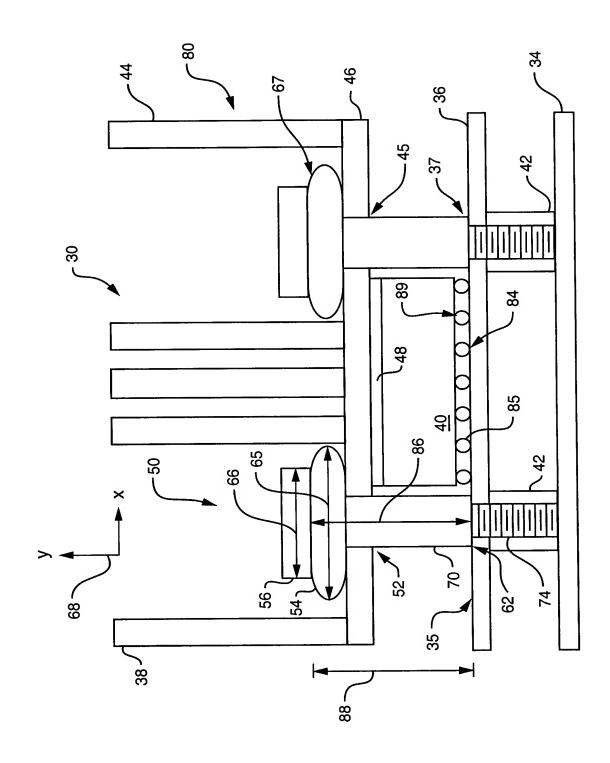


FIG. 5



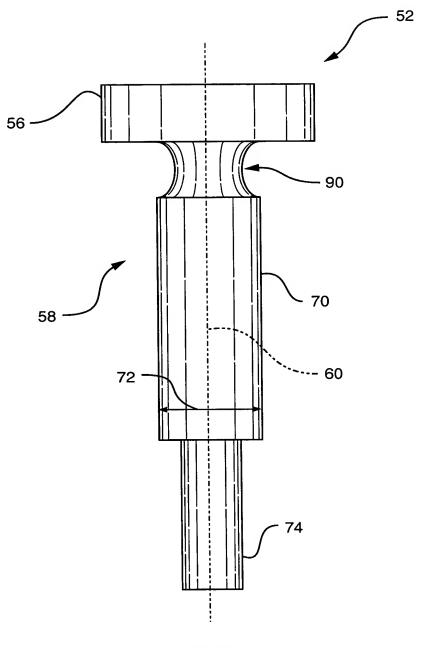


FIG. 6



100

PLACE A HEAT SINK IN COMMUNICATION WITH A CIRCUIT BOARD COMPONENT, THE CIRCUIT BOARD COMPONENT COUPLED TO A CIRCUIT BOARD 102

-104

SECURE THE HEAT SINK TO THE CIRCUIT BOARD COMPONENT USING A HEAT SINK ATTACHMENT MECHANISM, THE HEAT SINK ATTACHMENT MECHANISM HAVING A FASTENER HAVING A HEAD PORTION AND A SHAFT PORTION, THE SHAFT PORTION DEFINING A LONG AXIS AND HAVING A FLANGE SUBSTANTIALLY PERPENDICULAR TO THE LONG AXIS OF THE SHAFT PORTION AND THE HEAT SINK ATTACHMENT MECHANISM HAVING A COMPRESSIBLE MEMBER IN COMMUNICATION WITH THE SHAFT PORTION, THE HEAD PORTION, AND THE HEAT SINK

-106

CAUSE A FLANGE OF THE SHAFT PORTION TO ABUT A SURFACE OF THE CIRCUIT BOARD

-108

CAUSE THE HEAD PORTION TO COMPRESS THE COMPRESSIBLE MEMBER OF THE HEAT SINK ATTACHMENT MECHANISM AND EXPAND AN OUTER DIAMETER OF THE COMPRESSIBLE MEMBER

FIG. 7